# TFT DISPLAY SPECIFICATION





# 曜 凌 光 電 股 份 有 限 公 司 Raystar Optronics, Inc.

42881台中市大雅區科雅路25號5樓 5F, No. 25, Keya Road, Daya Dist., Taichung City 42881, Taiwan T:+886-4-2565-0761 | F:+886-4-2565-0760 sales@raystar-optronics.com | www.raystar-optronics.com

## RFH1010J-AYH-MNB

### **SPECIFICATION**

## **CUSTOMER:**

APPROVED BY
PCB VERSION
DATE

FOR CUSTOMER USE ONLY

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

Release DATE:

TFT Display Inspection Specification: <a href="https://www.raystar-optronics.com/download/products.htm">https://www.raystar-optronics.com/download/products.htm</a>
Precaution in use of TFT module: <a href="https://www.raystar-optronics.com/download/declaration.htm">https://www.raystar-optronics.com/download/declaration.htm</a>



# **Revision History**

VERSION	DATE	REVISED PAGE NO.	Note
0	2021/08/26		First issue



# **Contents**

- 1. Module Classification Information
- 2.Summary
- 3. General Specifications
- 4.Interface
- 5. Contour Drawing
- 6. Absolute Maximum Ratings
- 7. Electrical Characteristics
- 8.DC Electrical Characteristics
- 9.AC Electrical Characteristics
- 10. Function Description
- 11.MIPI Interface
- 12. Optical Characteristics
- 13.Reliability
- 14. Touch Panel Information
- 15.Initial Code For Reference
- 16.Other



# 1.Module Classification Information

R	F	Н	101	0J	-	Α	Υ	Н	-	М	N	В
1	2	3	4	5	-	6	7	8	-	9	10	11

Item	Description								
1	R : Raystar Optronics Inc.								
2	Display Type : F→TFT Type, J→ Custom TFT								
3	Solution: A: 128x160 B:320x234 C:320x24 F:800x480 G:640x480 H:1024x K:1280x800 L:240x400 M:1024x P:640x320 Q:800x600 S:480x1					600 768		E:480x272 J:240x320 O:480x800	
4	Display Size: 1	0.1" TF	Т						
5	Version Code.							)	
6	Model Type: A: TFT LCD E: TFT+FR+CONTROL BOARD J: TFT+FR+A/D BOARD N: TFT+FR+A/D BOARD+CONTROL BOARD S: TFT+FR+POWER BOARD (DC TO DC) 1: TFT+CONTROL BOARD								
7	Polarizer Type, Temperature range, View direction	olarizer Type, nperature range,  I→Transmissive, W. T, 6:00 ; C→Transmissive, N. T, 6:00 L→Transmissive, W.T,12:00 ; F→Transmissive, N.T,12:00 Y→Transmissive, W.T, IPS TFT  Z→Transmissive, W.T, O, TET							
8	Backlight	W : LE	V→Transmissive, Super W.T, VA TFT  W: LED, White						
9	Driver Method	D: Dig	ital A: A	nalog	L : L'	VDS	M:MIPI		
10	Interface	N : wit	N : without control board A : 8Bit B : 16Bit S:SPI Interface R: RS232 U:USB I: I2C						
11	TS	C : ca	ithout TS pacitive tou pacitive tou	ch pane	el cap	aciti	ouch panel ve touch pane	el (G-F-F)	







# 2.Summary

TFT 10.1" is a color active matrix thin film transistor (TFT) liquid crystal display without polarizer. This model is composed of amorphous silicon TFT as a switching device.

This TFT LCD has a 10.1" wide (16:9) diagonally measured active display area with WVGA (1024 horizontal by 600 vertical pixel) resolution. Each pixel is divided into Red, Green, Blue dots which are arranged in vertical stripes.



# 3.General Specifications

■ Size: 10.1 inch

■ Dot Matrix: 1024 RGB X 600 dots

■ Module dimension: 235(W) x143(H) x 8.78(D) mm

■ Active area: 222.72 (H) x 125.28(V) mm

■ Pixel pitch: 0.2175(W) x 0.2088(H) mm

■ LCD type: TFT, Normally Black, Transmissive

■ TFT Interface: 4-Lanes MIPI

■ Driver IC: EK79007AD3 + EK73217BCGA or equivalent

■ Viewing Angle: 85/85/85/85

■ Aspect Ratio: 16:9

■ Backlight Type: LED,Normally White

■ CTP IC: ILI2511 or equivalent

CTP Interface: USB (I2C available)

CTP FW Version: V6.0.0.0.62.90.1.2

■ With /Without TP: With CTP

Surface: Glare

\*Color tone slight changed by temperature and driving voltage.



# 4.Interface

# 4.1. TFT LCD MODULE

Pin No.	Symbol	Description
1	VLED+	LED Anode
2	VLED+	LED Anode
3	VGH	Positive power for TFT
4	VGL	Negative power for TFT
5	UPDN	Gate up or down scan control.  UPDN = "L", STV2 output vertical start pulse and UD pin output logical "L" to Gate driver. (default)  UPDN = "H", STV1 output vertical start pulse and UD pin output logical "H" to Gate driver
6	SHLR	Source right or left sequence control.  SHLR = "L", shift left: last data = S1←S2←S3←S1536 = first data.  SHLR = "H", shift right: first data = S1→S2→S3→S1536 = last data.(default)
7	VLED-	LED Cathode
8	VLED-	LED Cathode
9	AVDD	Analog power
10	GND	Digital ground
11	D3P	MIPI data input.
12	D3N	MIPI data input.
13	GND	Digital ground
14	D2P	MIPI data input.
15	D2N	MIPI data input.
16	GND	Digital ground
17	CLKP	MIPI clock input
18	CLKN	MIPI clock input
19	GND	Digital ground
20	D1P	MIPI data input.
21	D1N	MIPI data input.
22	GND	Digital ground
23	D0P	MIPI data input.
24	D0N	MIPI data input.
25	GND	Digital ground



26	STBYB	Standby mode. STBYB = "H",normal operation(default) STBYB = "L", timing controller, source driver will turn off, all output are GND.
27	RESET	Global reset pin. Active Low to enter Reset State. Normally pull high. Connecting with an RC reset circuit for stability.
28	VDD (1.8V)	Digital power
29	VDD (1.8V)	Digital power
30	VCOMI	Common voltage

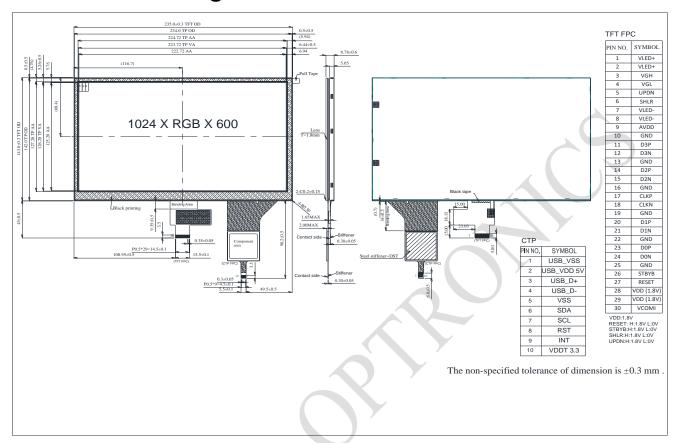
### 4.2. CTP PIN Definition

Pin	Symbol	Function	Remark
1	USB_VSS	System ground	
2	USB_VDD 5V	Power supply	
3	USB_D+	Data +	
4	USB_D-	Data -	
5	VSS	System ground	
6	SDA	I2C data input and output	
7	SCL	I2C clock input	
8	RST	External Reset, Low is active	
9	INT	External interrupt to the host	
10	VDDT 3.3	Power supply	

Note: Interface can support both USB and I2C,USB is main function Note 2 : Connect VSS(USB\_VSS) of CTP wtih TFT GND



# 5.Contour Drawing





# 6.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	TOP	-20	_	+70	
Storage Temperature	TST	-30	_	+80	

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

1. Temp.  $\Box 60\Box$ , 90% RH MAX. Temp.  $>60\Box$ , Absolute humidity shall be less than 90% RH at  $60\Box$ 



### 7. Electrical Characteristics

### 7.1. Typical Operation Conditions (At Ta = 25 °C,)

Item	Symbol	Min.	Тур.	Max.	Unit	Note
Digital Power Supply Voltage For LCD	VDD	1.71	1.8	1.89	V	Note1
Analog Power Supply Voltage	AVDD	9.89	10.2	10.5	V	-
Gate On Power Supply Voltage	VGH	19.4	20.0	20.6	٧	-
Gate Off Power Supply Voltage	VGL	-10.3	-10.0	-9.7	V	-
Common Power Supply Voltage	VCOMI	4.0	4.3	4.6	٧	Note2
	VDDT	3.0	3.3	3.6	V	I2C
Cumply CTD	IVDDT		90.5	115	mA	type
Supply CTP	USB_VDD 5V	4.4	5.0	5.5	V	USB
	I <sub>VDD 5V</sub>		97.8	120	mA	type

Note1:VDD setting should match the signals output voltage (refer to Note 3) of customer's system board.

Note 2.Please adjust VCOMI to make the flicker level be minimum.

Note 3:RESET,STBYB,U/D,L/R,SELB

7.2. Current Consumption

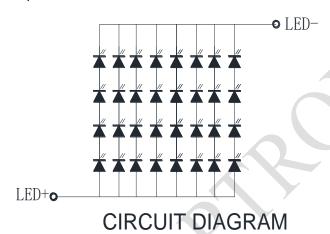
lto m	Sample of		Values		l lmi4	Domonic	
Item	Symbol	Min.	Тур.	Max.	Unit	Remark	
15	I <sub>VGH</sub>	1	0.5	1.0	mA	VGH =20.0V	
	I <sub>VGL</sub>	-	1.4	2.1	mA	VGL = -10.0V	
Current for Driver	I <sub>VDD</sub>	-	16	24	mA	VDD =1.8V	
	I <sub>AVDD</sub>	-	19	28.5	mA	AVDD =10.2V	
	I vcomin	1	0	-	mA	VCOMIN=4.3V	



7.3. Backlight Driving Conditions

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply voltage of white LED backlight	VL	10.8	12.4	14.0	V	Note 1
Current for LED backlight	IL	-	480	-	mA	
LED life time	-	50,000	-	-	Hr	Note2

Note 1: There are 1 Groups LED



Note 2 : Ta = 25  $^{\circ}$ C

Note 3: Brightness to be decreased to 50% of the initial value

Note 4: The single LED lamp case



# 8.DC Electrical Characteristics

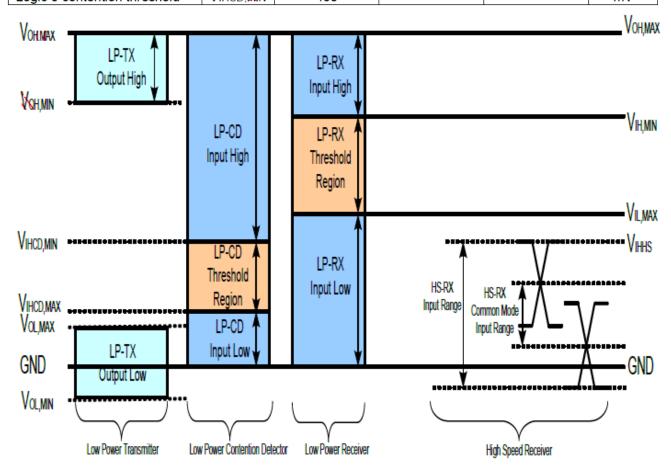
9.4 Dozomotor	Cymah al		Rating Typ Max		l lm:4	Condition
8.1. Parameter	Symbol	Min			Unit	Condition
Low level input voltage	VIL	0	-	0.3VDD	V	Note 1
High level input voltage	VIH	0.7VDD	-	VDD	V	Note 1

Note 1:RESET,STBYB, UPDN, SHLR



#### 8.2. MIPI Interface DC Characteristic

Parameter	Symbol	Min.	Тур.	Max.	Unit
	MIPI Charac	teristics for High S	peed Receiver		
Single-ended input low voltage	VILHS	-40	-	-	mV
Single-ended input high voltage	VIHHS		-	460	mV
Common-mode voltage	VCDRXDC	70	-	330	mV
Differential input impedance	ZID		100		ohm
HS transmit differential voltage(VOD=VDP-VDN)	[VOD]	140	200	250	mV
	MIPI Chara	acteristics for Low	Power Mode		•
Pad signal voltage range	Vı	-50	-	1350	mV
Ground shift	VGNDSH	-50	-	50	mV
Logic 0 input threshold	VIL	0	-	550	mV
Logic 1 input threshold	VIH	880	-	1350	mV
Input hysteresis	VHYST	25	-	-	mV
Output low level	Vol	-50	-	50	mV
Output high level	Voн	1.1	1.2	1.3	V
Output impedance of Low Power Transmitter	ZOLP	80	100	125	ohm
Logic 0 contention threshold	VILCD,MAX	-	-	200	mV
Logic 0 contention threshold	VIHCD,MIN	450	-	-	mV



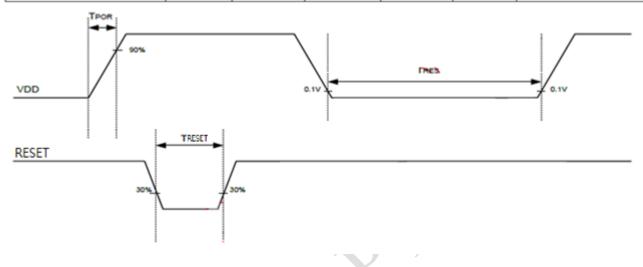


# 9.AC Electrical Characteristics

### 9.1. Basic AC Characteristic

VDD/RESET AC characteristic

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
VDD power slew rate	TPOR	-	-	20	ms	From 0 to 90% VDD
RESETactive pulse width	T <sub>RESET</sub>	1	-	-	ms	VDD=1.8V
VDD resettle time	TRES	1	-	-	s	

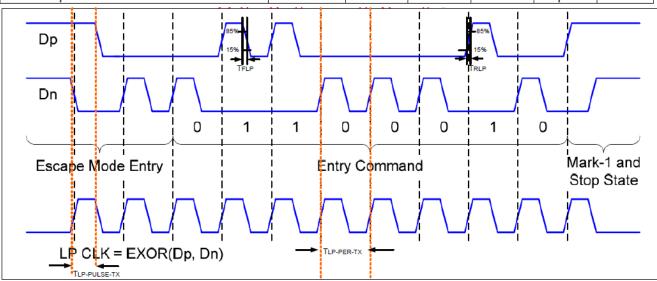




#### 9.2. MIPI AC Characteristic

#### 1.Transmitter AC Specification

Parameter		Symbol	Min	Тур	Max	Units	Notes
15%~85% risir	ng time and falling time	TRLP /TFLP	-	-	25	ns	-
30%~85% risir	ng time and falling time	TREOT	-	-	35	ns	-
Pulse width of LP	First LP EXOR clock pulse after STOP state or						-
exclusive-OR clock	Last pulse before stop state	TLP-PULSE-TX	40	-	-	ns	
	All other pulses		20	-	-	ns	-
Period of the L	P EXOR clock	TLP-PER-TX	90	-	-	mV/ns	-
Slew Rate @C	CLOAD =0pF		30	-	500	mV/ns	-
Slew Rate @C	LOAD =5pF	δ V/δ tsr	30	-	200	mV/ns	-
Slew Rate @C	CLOAD =20pF	]	30	-	150	mV/ns	-
Slew Rate @C	LOAD =70pF		30	-	100	mV/ns	-
Load Capacita	nce	TRLP	-	-	70	pF	-



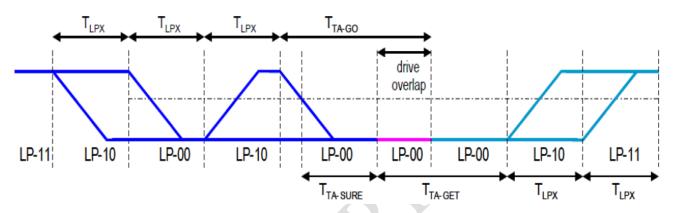
DP:MIPI\_D1P / MIPI\_D0P DN: MIPI\_D1N / MIPI\_D0N



### 2.Turnaround Procedure

**Turnaround Procedure Operation Timing Parameters** 

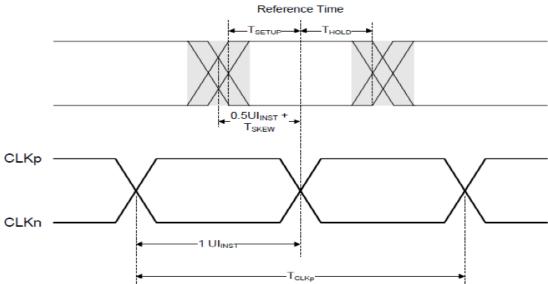
Parameter	Symbol	Min	Тур	Max	Units
Length of any Low-Power state period: Master side	TLPX	50	-	75	ns
Length of any Low-Power state period: Slave side	TLPX	50	55.56	58.34	ns
Ratio of TLPX(Master)/ TLPX (Slave) between Master	Ratio	2/3	-	3/2	
and Slave side	TLPX				
Time-out before new TX side start driving	TTA-Sure	TLPX	-	2T <sub>LPX</sub>	ns
Time to drive LP-00 by new TX	T <sub>TA-GET</sub>	-	5TLPX	-	ns
Time to drive LP-00 after Turnaround Request	T <sub>TA-GO</sub>	-	4TLPX	-	ns





### 3.High speed transmission

Parameter	Symbol	Min	Тур	Max	Units
UI instantaneous	UIINST	2	-	12.5	ns
Data to Clock	TSKEW(TX)	-0.15	-	0.15	UIINST
Skew(measured at					
transmitter)					
Data to Clock Setup	TSETUP(RX)	0.15	-	-	UIINST
time(measured at receiver)					
Data to Clock Hold	THOLD(RX)	0.15	-	-	UIINST
time(measured at receiver)					
20%~80% rise time and fall	Tr, Tf	150	-	-	ps
time		-	-	0.3	UIINST



CLKP: MIPI\_CLKP CLKN: MIPI\_CLKN

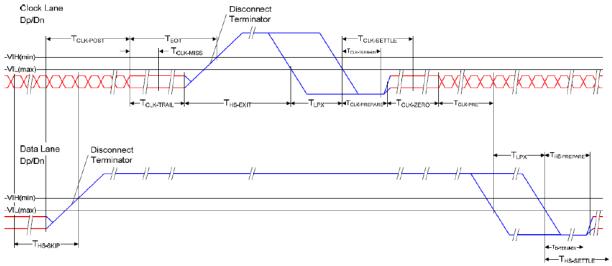


### 4.High Speed Clock Transmission

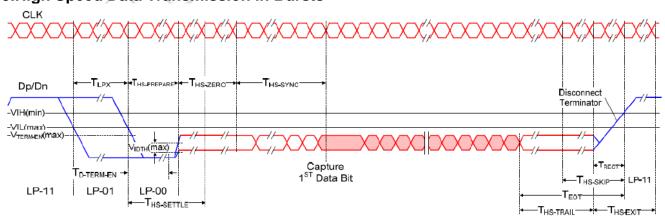
DP:MIPI\_D1P / MIPI\_D0P DN: MIPI\_D1N / MIPI\_D0N

CLKP: MIPI\_CLKP CLKN: MIPI\_CLKN

Parameter	Symbol	Min	Тур	Max	Units
Time that the transmitter shall continue sending	TCLK-POST	60+52UI	-	-	ns
HS clock after the last associated Data Lane has transitioned to LP mode					
Detection time that the clock has stopped	TCLK-MISS	-	-	60	ns
toggling					
Time to drive LP-00 to prepare for HS clock	TCLK-PREPARE	38	-	95	ns
transmission					
Minimum lead HS-0 drive period before starting	TCLK-PREPARE	300	-	-	ns
clock	+ TCLK-ZERO				
Time to enable Clock Lane receiver line	THS-TERM-EN	-	-	38	ns
termination measured from when Dn cross					
VIL,MAX					
Minimum time that the HS clock must be prior to	TCLK-PRE	8	-	-	UI
any associated data lane beginning the					
transmission from LP to HS mode					
Time to drive HS differential state after last	TCLK-TRAIL	60	-	-	ns
payload clock bit of a HS transmission burst					



#### 5. High Speed Data Transmission in Bursts

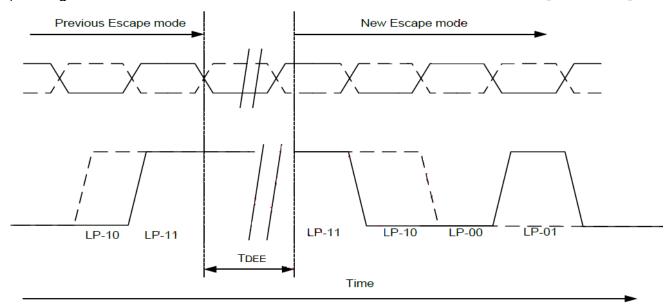




#### 6.LP11 timing request between data transformation

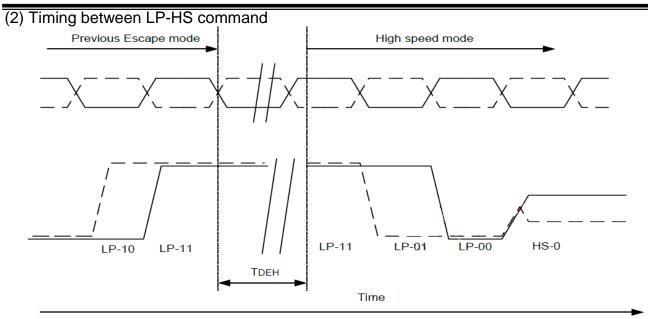
When Clock lane of DSI TX chip always keeps High speed mode, then Clock lane never go back to Low power mode. If Date lane of TX chip needs to transmit the next new data transmission or sequence, after the end of Low power mode or High speed mode or BTA. Then TX chip needs to keep LP-11 stop state before the next new data transmission, no matter in Low power mode or High speed mode or BTA. The LP-11 minimum timing is required for RX chip in the following 9 conditions, include of LP—LP, LP—HS, HS— LP, HS—HS, BTA—BTA, LP—BTA, BTA—LP, HS—BTA, and BTA—HS. This rule is suitable for short or long packet between TX and RX data transmission.

#### (1) Timing between LP-LP command

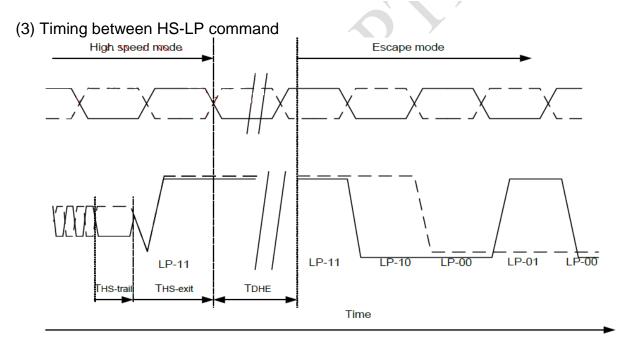


Parameter	Symbol	Min	Тур	Max	Unit
LP-11 delay to start of the new Escape Mode Entry	TDEE	150	-	-	ns





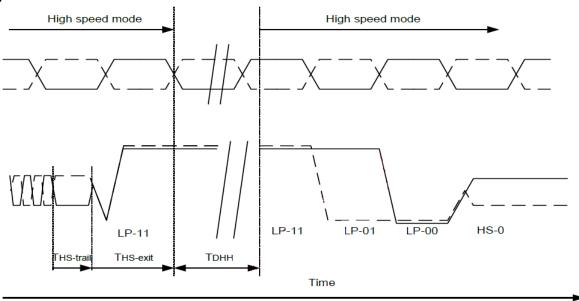
Parameter	Symbol	Min	Тур	Max	Unit
LP-11 delay to start of the Entering High	TDEH	Max(150,32UI)	-	-	ns
Speed Mode					



Parameter	Symbol	Min	Тур	Max	Unit
LP-11 delay to start of the Escape Mode	TDHE	Max(150,32UI)	-	-	ns
Entry					

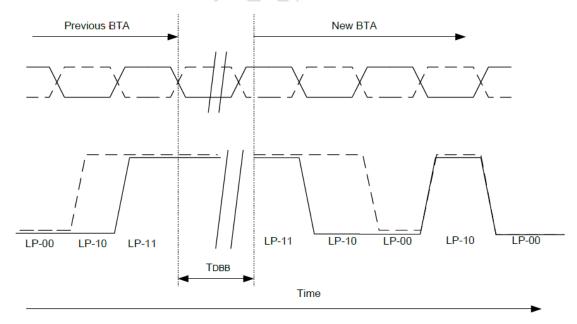


### (4) Timing between HS-HS command



Parameter	Symbol	Min	Тур	Max	Unit
LP-11 delay to start of the Entering High	TDHH	Max(150,32UI)	-	-	ns
Speed Mode					

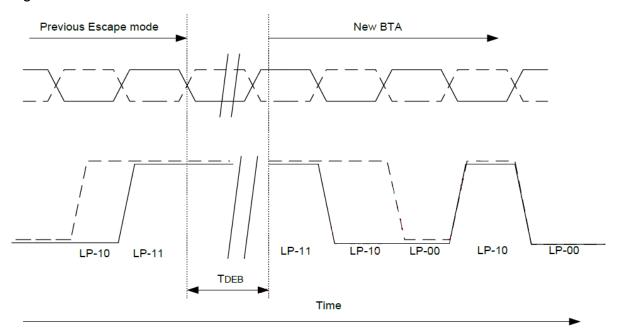
### (5) Timing between BTA-BTA command



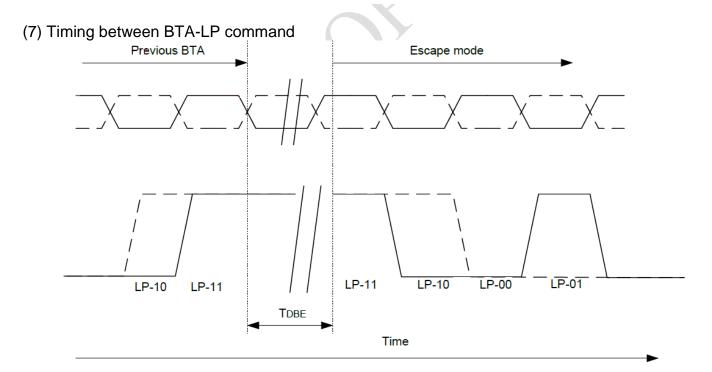
Parameter	Symbol	Min	Тур	Max	Unit
LP-11 delay to start of the new BTA	TDBB	150	-	-	ns



### (6) Timing between LP-BTA command



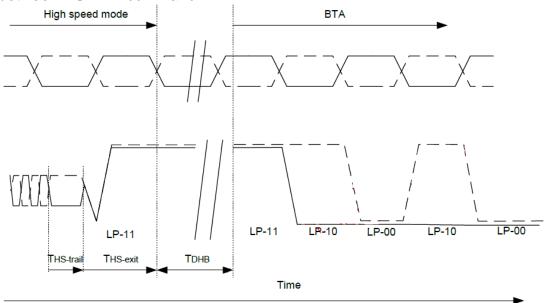
Parameter	Symbol	Min	Тур	Max	Unit
LP-11 delay to start of the new BTA	TDEB	150	-	-	ns



Parameter	Symbol	Min	Тур	Max	Unit
LP-11 delay to start of the Escape Mode Entry	TDBE	150	-	-	ns

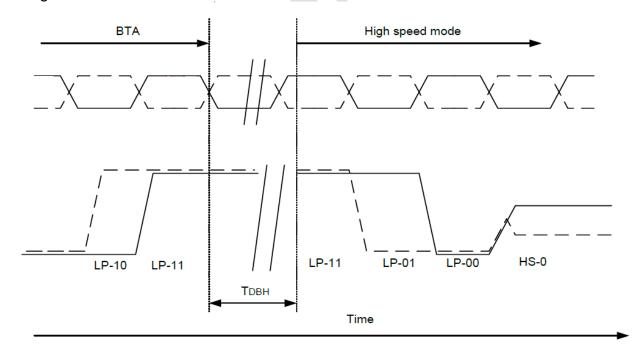






Parameter	Symbol	Min	Тур	Max	Unit
LP-11 delay to start of the BTA	TDHB	Max(150,32UI)	-	-	ns

### (9) Timing between BTA-HP command



Parameter	Symbol	Min	Тур	Max	Unit
LP-11 delay to start of the Entering High	TDBH	Max(150,32UI)	-	-	ns
Speed Mode					

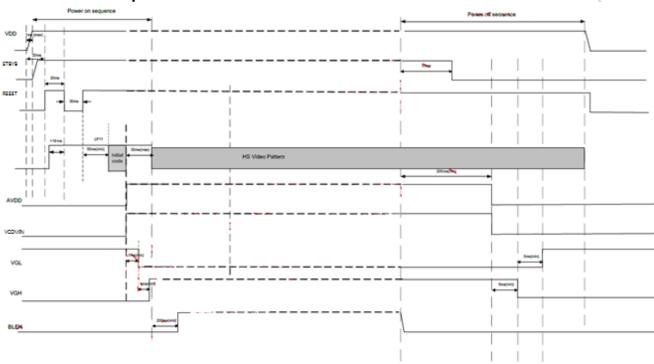


# **10.Function Description**

#### 10.1. Power On/Off Sequence

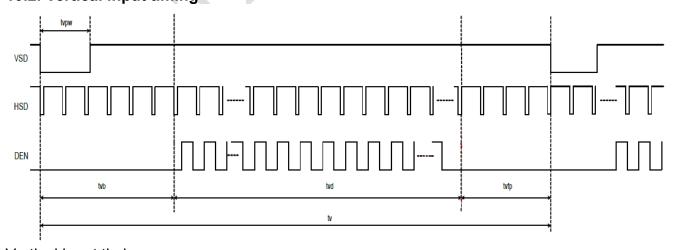
In order to prevent IC from power on reset fail, the rising time (TPOR) of the digital power supply VDD should be maintained within the given specifications. Refer to "AC Characteristics" for more detail on timing.

#### **Power On/Off Sequence**



Note: CLK and Data Lanes should keep in LP11(stop state) before RESET.

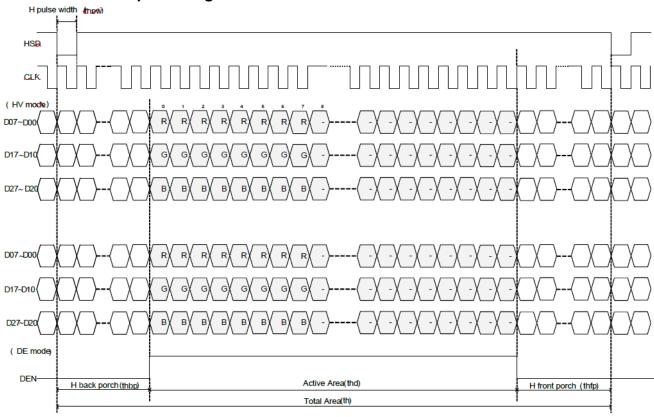
#### 10.2. Vertical input timing



Vertical input timing







Horizontal input timing

# 10.4. Input Timing Table (2Lane) For 1024RGB x 600 panel

DE mode

Parameter	Symbol		Unit		
Faidilletei	Symbol	Min.	Тур.	Max.	Offit
DCLK frequency @Frame rate=60hz	DCLK frequency @Frame rate=60hz fclk 40.8 51.2		.2	Mhz	
Horizontal display area	thd		1024		
HSYNC period time	th	1114	1344		DCLK
HSYNC blanking	thb+thfp	90	320		DCLK
Vertical display area	Tvd	Tvd 600		Н	
VSYNC period time	VSYNC period time Tv 610 635		35	Н	
VSYNC blanking	Tvb+Tv¶p	10	3	5	Н



#### HV mode

### Horizontal input timing

Parameter		Symbol	Value			Unit
Horizontal display area		thd	1024			DCLK
DCLK frequency@ Frame rate=60hz		fclk	Min.	Тур.	Max.	
		ICIN	44.9	51.2		Mhz
1 Hor <mark>izo</mark> ntal Line		th	1200 1344			
	Min.			1		
HSYNC pulse width	Тур.	thpw	70			DCLK
	Max.		140			DCLK
HSYNC blanking		thb	160	16	60	
HSYNC front porc	h	thfp	16	16	60	

### HV mode

# Vertical input timing

Parameter	Symbol		Unit		
Farameter	Symbol	Min.	Тур.	Max.	Offic
Vertical display area	tvd	600		Н	
VSYNC period time	tv	624	635		Н
VSYNC pulse width	tvpw	1	20		Н
VSYNC back porch	tvb	23	23		Н
VSYNC front porch	tvfp	1	12		Н



#### 11.MIPI Interface

#### 11.1. MIPI INTERFACE (MOBILE INDUSTRY PROCESSING INTERFACE)

The Display Serial Interface standard defines protocols between a host processor and peripheral devices that adhere to MIPI Alliance standards for mobile device interfaces. The DSI standard builds on existing standards by adopting pixel formats and command set defined in MIPI Alliance standards.

DSI-compliant peripherals support either of two basic modes of operation: Command Mode and Video Mode. Which mode is used depends on the architecture and capabilities of the peripheral. The mode definitions reflect the primary intended use of DSI for display interconnect, but are not intended to restrict DSI from operating in other applications. Command Mode refers to operation in which transactions primarily take the form of sending commands and data to a peripheral, such as a display module, that incorporates a display controller. The display controller may include local registers. Systems using Command Mode write to, and read from, the registers. The host processor indirectly controls activity at the peripheral by sending commands, parameters and data to the display controller. The host processor can also read display module status information. Command Mode operation requires a bidirectional interface.

Video Mode refers to operation in which transfers from the host processor to the peripheral take the form of a real-time pixel stream. In normal operation, the display module relies on the host processor to provide image data at sufficient bandwidth to avoid flicker or other visible artifacts in the displayed image. Video information should only be transmitted using High Speed Mode. To reduce complexity and cost, systems that only operate in Video Mode may use a unidirectional data path.

MIPI Lane Configuration:

	MCU (Master) Display Module (Slave)				
Clock Lane	Unidirectional Lane				
	Clock Only				
	Escape Mode(ULPS Only)				
Data Lane0	Bi-directional Lane				
	<ul> <li>Forward High-Speed</li> </ul>				
	<ul> <li>Bi-directional Escape Mode</li> <li>Bi-directional LPDT</li> </ul>				
Data Lane1	Unidirectional				
	Forward High speed				



#### 11.2. Display Serial Interface (DSI)

#### **Video Mode Communication**

Video Mode peripherals require pixel data delivered in real time. This section specifies the format and timing of DSI traffic for this type of display module.

#### **Transmission Packet Sequences**

DSI supports several formats, or packet sequences, for Video Mode data transmission. The peripheral's timing requirements dictate which format is appropriate. These terms are used throughout the following sections:

Non-Burst Mode with Sync Pulses — enables the peripheral to accurately reconstruct original video timing, including sync pulse widths.

Non-Burst Mode with Sync Events — similar to above, but accurate reconstruction of sync pulse widths is not required, so a single Sync Event is substituted.

Burst mode — RGB pixel packets are time-compressed, leaving more time during a scan line for LP mode(saving power) or for multiplexing other transmissions onto the DSI link.

In the following figures the Blanking or Low-Power Interval (BLLP) is defined as a period during which video packets such as pixel-stream and sync event packets are not actively transmitted to the peripheral. To enable PHY synchronization the host processor should periodically end HS transmission and drive the Data Lanes to the LP state. This transition should take place at least once per frame; shown as LPM in the figures in this section. It is recommended to return to LP state once per scanline during the horizontal blanking time. Regardless of the frequency of BLLP periods, the host processor is responsible for meeting all documented peripheral timing requirements. Note, at lower frequencies BLLP periods will approach, or become, zero.

During the BLLP the DSI Link may do any of the following:

Remain in Idle Mode with the host processor in LP-11 state and the peripheral in LP-RX. Transmit one or more non-video packets from the host processor to the peripheral using Escape Mode.

Transmit one or more non-video packets from the host processor to the peripheral using HS Mode.

If the previous processor-to-peripheral transmission ended with BTA, transmit one or more packets from the peripheral to the host processor using Escape Mode.

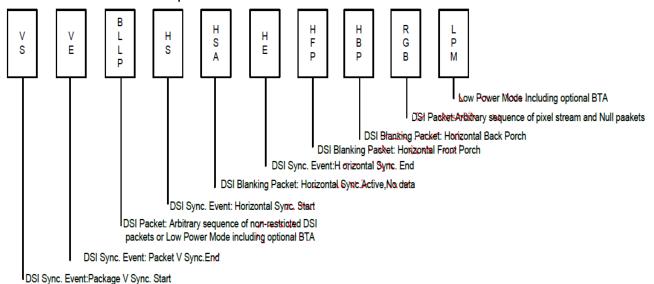
Transmit one or more packets from the host processor to a different peripheral using a different Virtual Channel ID.

The sequence of packets within the BLLP or RGB portion of a HS transmission is arbitrary. The host processor may compose any sequence of packets, including iterations, within the limits of the packet format definitions. For all timing cases, the first line of a frame shall start with VS; all other lines shall start with HS. This is also true in the special case when VSA+VBP=0. Note that the position of synchronization packets, such as VS and HS, in time is of utmost importance since this has a direct impact on the visual performance of the display panel.

Normally, RGB pixel data is sent with one full scan line of pixels in a single packet. Individual pixels shall not be split across packets.



Transmission packet components used in the figures in this section are defined in Figure below unless otherwise specified.



#### **DSI Video Mode Interface Timing Legend**

If a peripheral timing specification for HBP or HFP minimum period is zero, the corresponding Blanking Packet may be omitted. If the HBP or HFP maximum period is zero, the corresponding blanking packet shall be omitted.

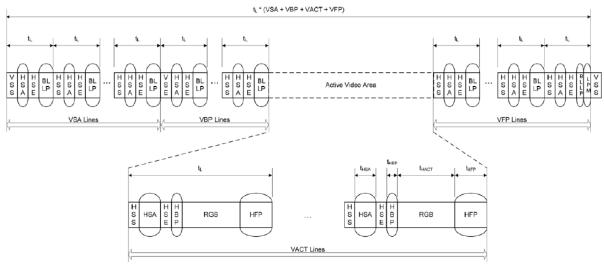
#### **Clock Requirements**

A DSI host processor shall support continuous clock on the Clock Lane for display module that require it, so the host processor needs to keep the HS serial clock running.



#### Non-Burst Mode with Sync Pulses

With this format, the goal is to accurately convey DPI-type timing over the DSI serial Link. This includes matching DPI pixel-transmission rates, and widths of timing events like sync pulses. Accordingly, synchronization periods are defined using packets transmitting both start and end of sync pulses. An example of this mode is shown in Figure below.

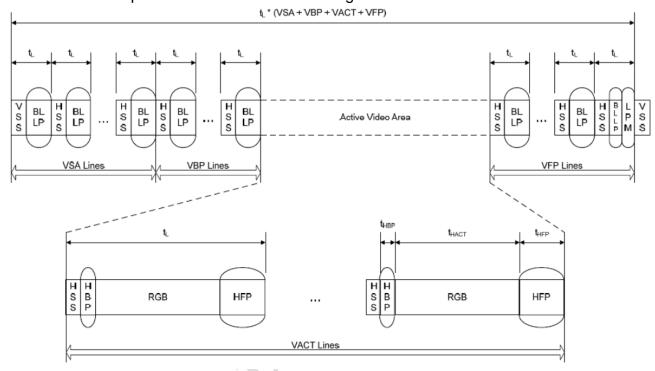


Normally, periods shown as I (Horizontal Sync Active), HBP (Horizontal Back Porch) and HFP (Horizontal Front Porch) are filled by Blanking Packets, with lengths (including packet overhead) calculated to match the period specified by the peripheral's data sheet. Alternatively, if there is sufficient time to transition from HS to LP mode and back again, a timed interval in LP mode may substitute for a Blanking Packet, thus saving power



#### **Non-Burst Mode with Sync Events**

This mode is a simplification of the format described in section "Non-Burst Mode with Sync Pulse" .Only the start of each synchronization pulse is transmitted. The peripheral may regenerate sync pulses as needed from each Sync Event packet received. Pixels are transmitted at the same rate as they would in a corresponding parallel display interface such as DPI-2. An example of this mode is shown in Figure below.

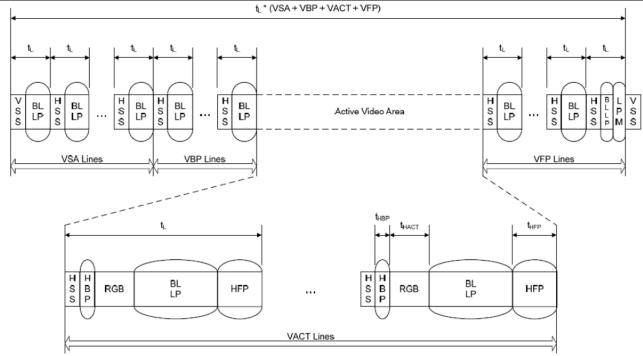


As with the previous Non-Burst Mode, if there is sufficient time to transition from HS to LP mode and back again, a timed interval in LP mode may substitute for a Blanking Packet, thus saving power.

#### **Burst Mode**

In this mode, blocks of pixel data can be transferred in a shorter time using a time-compressed burst format. This is a good strategy to reduce overall DSI power consumption, as well as enabling larger blocks of time for other data transmissions over the Link in either direction. There may be a line buffer or similar memory on the peripheral to accommodate incoming data at high speed. Following HS pixel data transmission, the bus goes to Low Power Mode, during which it may remain idle, i.e. the host processor remains in LP-11 state, or LP transmission may take place in either direction. If the peripheral takes control of the bus for sending data to the host processor, its transmission time shall be limited to ensure data underflow does not occur from its internal buffer memory to the display device. An example of this mode is shown in Figure below





Similar to the Non-Burst Mode scenario, if there is sufficient time to transition from HS to LP mode and back again, a timed interval in LP mode may substitute for a Blanking Packet, thus saving power.



12. Optical Characteristics

Item		Symbol	Condition.	Min	Тур.	Max.	Unit	Remark
Response time		Tr	θ=0°、Φ=0°		10	20	.ms	Note 3
Response	ume	Tf	$\theta$ =0 $\Phi$ =0	-	20	25	.ms	Note 3
Contrast r	atio	CR	At optimized viewing angle	600	800	-	-	Note 4
Color	White	Wx	θ=0°、Φ=0	0.252	0.302	0.352	-	Note
Chromaticity	vvriite	Wy	$\theta = 0$ , $\Phi = 0$	0.274	0.324	0.374		2,6,7
	Han	ΘR		80	85			
Viewing	Hor.	ΘL	CR≧10	80	85	-	Dog	Note 1
angle	Ver.	ФТ	CR≦10	80	85	-	Deg.	Note i
	ver.	ФВ		80	85	-		
Brightne	SS	-	-	800	900	-	cd/m²	Center of display
Uniform	ity	(U)	-	70		-	%	Note 5

Ta=25±2°C

Note 1: Definition of viewing angle range

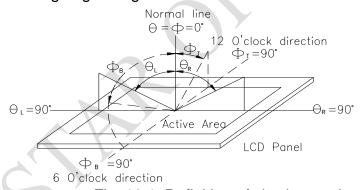


Fig. 12.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7 or BM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.



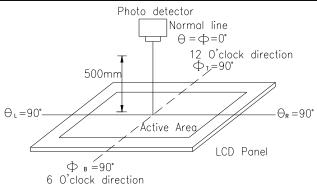
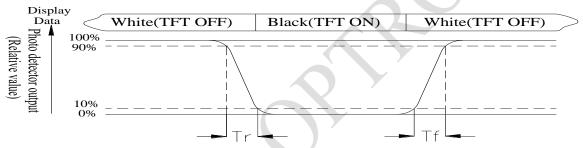


Fig. 12.2. Optical measurement system setup

#### Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, Tr, is the time between photo detector output intensity changed from 90%to 10%. And fall time, Tf, is the time between photo detector output intensity changed from 10%to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.



Note 5: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (reference the picture in below). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U) = Lmin/Lmax x100%

L = Active area length

W = Active area width

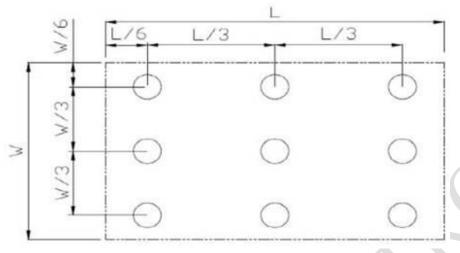


Fig 12.3. Definition of uniformity

Note 6: Definition of color chromaticity (CIE 1931) Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.



# 13.Reliability

Content of Reliability Test (Wide temperature, -20□~70□)

Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature	Endurance test applying the high storage temperature	80□	2
storage	for a long time.	200hrs	
Low Temperature	Endurance test applying the low storage temperature	-30□	1,2
storage	for a long time.	200hrs	
High Temperature	Endurance test applying the electric stress (Voltage &	70□	
Operation	Current) and the thermal stress to the element for a long time.	200hrs	
Low Temperature	Endurance test applying the electric stress under low	-20□	1
Operation	temperature for a long time.	200hrs	
High Temperature/	The module should be allowed to stand at	60□,90%RH	1,2
Humidity Operation	60□,90%RH max	96hrs	
Thermal shock	The sample should be allowed stand the following 10	-20□/70□	
resistance	cycles of	10 cycles	
	operation		
	-20□ 25□ 70□		
	00 1 5 1 00 1		
	30min 5min 30min		
\rac{1}{2} \cdot \	1 cycle	T	
Vibration test	Endurance test applying the vibration during	Total fixed	3
	transportation and using.	amplitude : 1.5mm	
		Vibration Frequency:	
		10~55Hz One cycle 60	
		seconds to 3	
		directions of X,Y,Z for	
		Each 15 minutes	
Static electricity test	Endurance test applying the electric stress to the		
Static electricity test	terminal.	VS=±600V(contact)	
	terrinal.	,±800v(air),	
		RS=330Ω	
		CS=150pF	
	7	10 times	

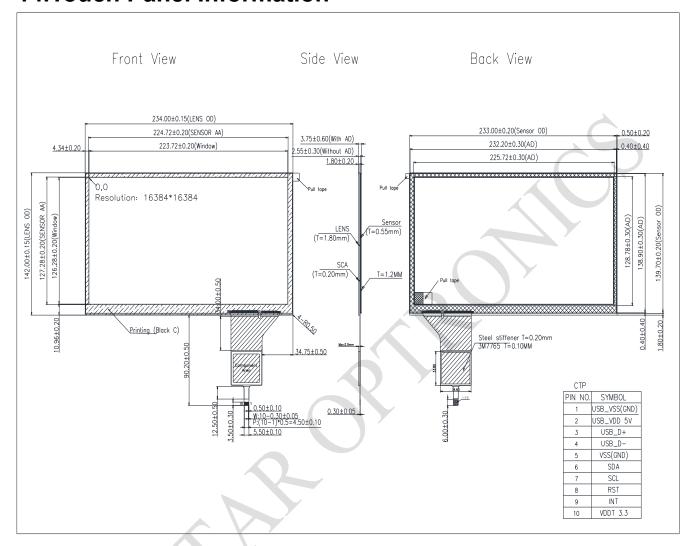
Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.



# 14.Touch Panel Information





### 15.Initial Code For Reference

command:

// 0x10=2LANE

```
regw(0xB2,0x10); //Panel Control Register NW/2 Lanes // 0x30=4LANE // 0x20=3LANE
```

regw(0x80,0x5B); //Gamma Control Register G2R/G1R regw(0x81,0x47); //Gamma Control Register G4R/G3R regw(0x82,0x84); //Gamma Control Register G6R/G5R regw(0x83,0x88); //Gamma Control Register G8R/G7R regw(0x84,0x88); //Gamma Control Register G10R/G9R regw(0x85,0x23); //Gamma Control Register G12R/G11R regw(0x86,0xB6); //Gamma Control Register G14R/G13R

<sup>\*</sup> Use MIPI Short Packet (0x15) To Write Command and Parameter



Page: 1

	LCM Sample	Estimate Feedback Sheet			
Module Number:					
1 · Panel Specification :					
1. Panel Type:	□ Pass	□ NG ,			
2. View Direction:	□ Pass	□ NG ,			
3. Numbers of Dots:	□ Pass	□ NG ,			
4. View Area:	□ Pass	□ NG ,			
5. Active Area:	□ Pass	□ NG ,			
6.Operating Temperature:	□ Pass	□ NG ,			
7.Storage Temperature:	□ Pass	□ NG ,			
8.Others:					
2 · Mechanical Specification :					
1. PCB Size :	□ Pass	□ NG ,			
2.Frame Size :	□ Pass	□ NG ,			
3.Materal of Frame:	□ Pass	□ NG ,			
4.Connector Position:	□ Pass	□ NG ,			
5.Fix Hole Position:	□ Pass	□ NG ,			
6.Backlight Position:	□ Pass	□ NG ,			
7. Thickness of PCB:	□ Pass	□ NG ,			
8. Height of Frame to PCB:	□ Pass	□ NG ,			
9.Height of Module:	□ Pass	□ NG ,			
10.Others:	□ Pass	□ NG ,			
3 · Relative Hole Size :					
1.Pitch of Connector:	□ Pass	□ NG ,			
2.Hole size of Connector:	□ Pass	□ NG ,			
3.Mounting Hole size:	□ Pass	□ NG ,			
4.Mounting Hole Type:	□ Pass	□ NG ,			
5.Others:	□ Pass	□ NG ,			
4 · Backlight Specification :					
1.B/L Type:	□ Pass	□ NG ,			
2.B/L Color:	□ Pass	□ NG ,			
3.B/L Driving Voltage (Referen	ce for LED Ty	/pe):□ Pass □ NG ,			
4.B/L Driving Current:	□ Pass	□ NG ,			
5.Brightness of B/L:	□ Pass	□ NG ,			
6.B/L Solder Method:	□ Pass	□ NG ,			
7.Others:	□ Pass	□ NG ,			

>> Go to page 2 <<



Page: 2 **Module Number**: 5 · Electronic Characteristics of Module : 1.Input Voltage: □ <u>NG</u> ,\_\_\_\_\_ □ Pass 2.Supply Current: □ Pass □ NG ,\_\_\_\_\_ □ NG ,\_\_\_\_\_ 3.Driving Voltage for LCD: □ Pass 4.Contrast for LCD: □ NG ,\_\_\_\_\_ □ Pass 5.B/L Driving Method: □ Pass □ NG ,\_\_\_\_\_ □ NG ,\_\_\_\_\_ 6.Negative Voltage Output: □ Pass □ NG ,\_\_\_\_\_ 7.Interface Function: □ Pass □ NG ,\_\_\_\_ 8.LCD Uniformity: □ Pass 9.ESD test: □ Pass □ NG ,\_\_\_\_\_ 10.Others: □ Pass □ NG ,\_\_\_\_\_ 6 \ Summary :

Date: / /

Sales signature : \_\_\_\_\_

Customer Signature : \_\_\_\_\_

### **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for TFT Displays & Accessories category:

Click to view products by Raystar manufacturer:

Other Similar products are found below:

F3ET2-005-150 HDA430T-3G1H NB7W-KBA04 NB-ATT01 NB5Q-ATT01 NB5Q-KBA04 NB-CN001 OAI-80038AA-2008-A 315U004B15300 TCG121WXLRXVNNANX35 EIC-LCD-1080P T-55619GD065J-LW-ABN NLB150XG02L-01 NL192108AC10-01D
NL6448AC18-08F NL8060BC26-35BA NL6448BC26-26D NL8060BC31-50F TM070DDHG03-40 PTPW16-070WV1S02 PTPW16084SV1S02 MTD0300ECP06DF-1 4DLCD-35480320-CTP-IPS 4DLCD-35480320-IPS 4DLCD-35480320-RTP-IPS 4DLCD-50800480CTP-IPS RFA6400E-AWH-DNG RFE430V-AZW-DNS RFF70BQ-1IW-DBG RFF70VA2-1IW-DHS RFH700A8-AYH-MNN RFK101VF1YH-LHG RFS52VA-1ZH-DHN SM-RVT101HVHFWN00 SM-RVT101HVHNWC00 SM-RVT101HVHNWCA0 SMRVT101HVHNWN00 SM-RVT101HVLFWCA0 SM-RVT101HVLNWCA0 SM-RVT35HHTFWCA0 SM-RVT35HHTNWCA0 SMRVT43HLTFWCA0 SM-RVT43HLTNWCA0 SM-RVT50HQTFWCA0 SM-RVT50HQTNWCA0 SM-RVT70AQLFWR00 SMRVT70AQLNWR00 SM-RVT70HSLFWCA0 SM-RVT70HSMFWCA0 SM-RVT70HSMFWN00